



JOCHA14B-D8P/S Series

Rev.A.1.0

DESCRIPTION:

The products are 10MBd high-speed opto-couplers in a plastic DIP8 package with different lead forming options. o

ABSOLUTE MAXIMUM RATINGS (Temperature=25°C)

Parameter		Symbol	Value	Unit
Input	Forward Current	I _F	50	mA
	Peak Forward Current	I _{FP}	1	A
	Reverse Voltage	V _R	6	V
	Input Power Dissipation	P _D	100	mW
Output	Supply Voltage	V _{CC}	7	V
	Output Voltage	V _O	7	V
	Output Current	I _O	50	mA
	Output Power Dissipation	P _O	85	mW
Total Power Dissipation		P _{tot}	200	mW
Isolation Voltage		V _{iso}	5000	V _{rms}
Operating Temperature		T _{opr}	-40~110	
Junction Temperature		T _j	125	
Storage Temperature		T _{stg}	-55~125	
Soldering Temperature		T _{sol}	260	

NOTE1: 1. 2. 3. 4. 5. 6. 7. 8. 9. 10. 11. 12. 13. 14. 15. 16. 17. 18. 19. 20. 21. 22. 23. 24. 25. 26. 27. 28. 29. 30. 31. 32. 33. 34. 35. 36. 37. 38. 39. 40. 41. 42. 43. 44. 45. 46. 47. 48. 49. 50. 51. 52. 53. 54. 55. 56. 57. 58. 59. 60. 61. 62. 63. 64. 65. 66. 67. 68. 69. 70. 71. 72. 73. 74. 75. 76. 77. 78. 79. 80. 81. 82. 83. 84. 85. 86. 87. 88. 89. 90. 91. 92. 93. 94. 95. 96. 97. 98. 99. 100.

NOTE2: 1. 2. 3. 4. 5. 6. 7. 8. 9. 10. 11. 12. 13. 14. 15. 16. 17. 18. 19. 20. 21. 22. 23. 24. 25. 26. 27. 28. 29. 30. 31. 32. 33. 34. 35. 36. 37. 38. 39. 40. 41. 42. 43. 44. 45. 46. 47. 48. 49. 50. 51. 52. 53. 54. 55. 56. 57. 58. 59. 60. 61. 62. 63. 64. 65. 66. 67. 68. 69. 70. 71. 72. 73. 74. 75. 76. 77. 78. 79. 80. 81. 82. 83. 84. 85. 86. 87. 88. 89. 90. 91. 92. 93. 94. 95. 96. 97. 98. 99. 100.

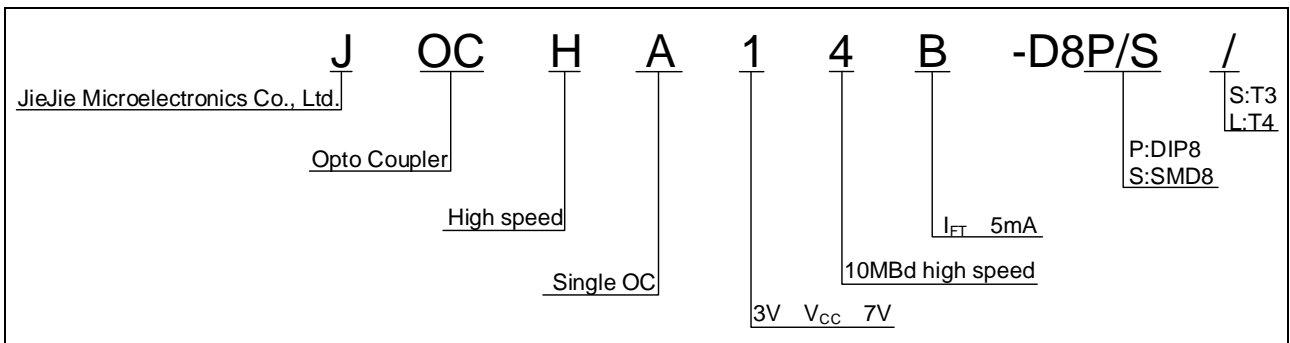
ELECTRICAL CHARACTERISTICS (Temperature=25°C)

Parameter		Symbol	Condition	Min.	Typ.	Max.	Unit
Input	Forward Voltage	V _F	I _F =10mA	-	1.35	1.6	V
	Reverse Current	I _R	V _R =6V	-	-	1	μA
	Input Capacitance	C _{in}	V=0, f=1MHz	-	34	-	pF
Output	High Level Current	I _{OH}	I _F =250μA, V _{CC} =3.3V, V _O =3.3V, V _E =2V	-	5	100	μA
	High Level Supply Current	I _{CCH}	V _{CC} =3.3V, I _F =0mA, V _E =0.5V	-	-	10	mA
	Low Level Supply Current	I _{CCL}	V _{CC} =3.3V, I _F =10mA, V _E =0.5V	-	-	13	mA

	Logic Low Output Voltage	V_{OL}	$I_F=5mA,$ $I_o=13mA,$ $V_{CC}=3.3V,$ $V_E=2V$	-	0.3	0.6	V
	Isolation Resistance	R_{ISO}	DC500V 40~60%R.H.	-	10^{12}	-	
	Floating Capacitance	C_{IO}	$V=0, f=1MHz$	-	1	-	pF
Switching Characteristics	Trigger LED Current	I_{FT}	$V_{CC}=5V,$ $V_O=V_{OL}$	-	-	5	mA
	Propagation Delay Time to Logic Low	t_{PHL}	$C_L=15pF,$ $R_L=350 \Omega,$ $I_F=7.5mA$	-	-	60	ns
	Propagation Delay Time to Logic High	t_{PLH}		-	-	60	ns
	Pulse width distortion	$ t_{PHL}-t_{PLH} $		-	-	35	ns
	Common Mode Transient Immunity at Logic High	CM_H	$V_{CC}=3.3V,$ $I_F=4000A,$ $R_{COM}=1000V,$ $R_L=350$	10	15	-	kV/ μs
Common Mode Transient Immunity at Logic Low	CM_L	$V_{CC}=3.3V,$ I_{Fm}	v		10	15	-

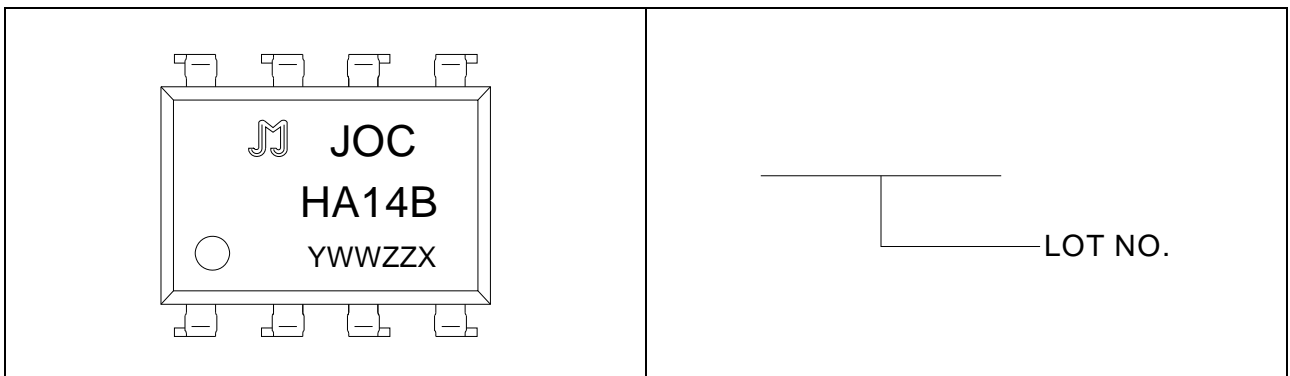
High Level Input Current	I_{FH}	7	-	15	mA
Output Pull-up Resistor	R_L	330	-	4k	
Fan Out (at $R_L=1k$ per channel)	N	-	-	5	TTL Loads

ORDERING INFORMATION



Packing Quantity	
Option	Quantity
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MARKING



Characteristics Curves

FIG.1: High Level Output Current vs. Ambient Temperature



FIG.2: High Level Output Current vs. Ambient Temperature

FIG.7:

FIG.13: Pulse Width Distortion vs. Ambient Temperature

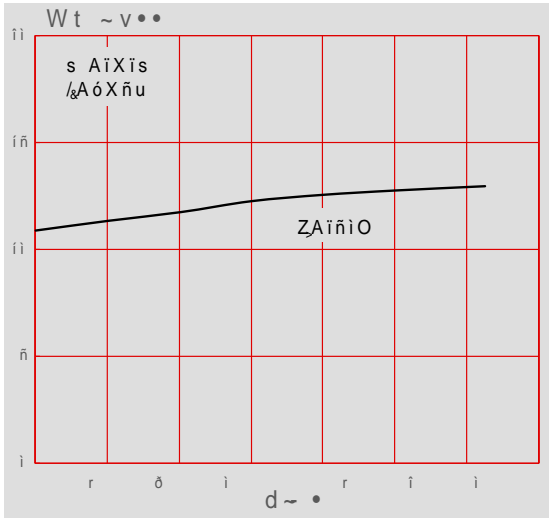
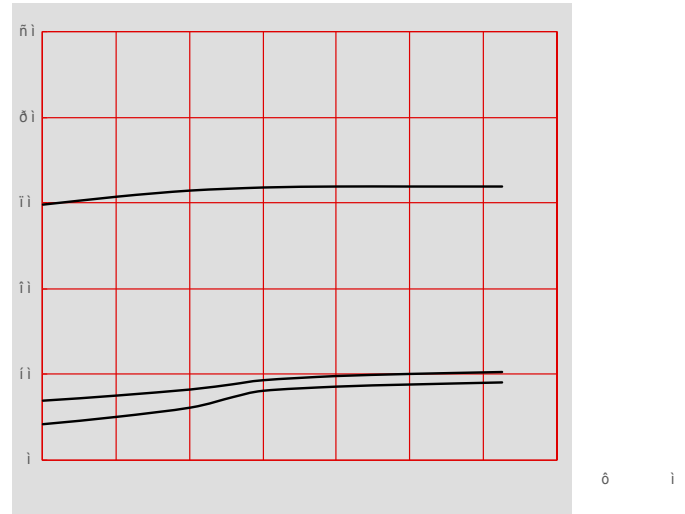
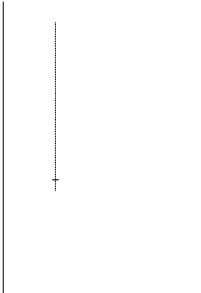


FIG.14: Pulse Width Distortion vs. Ambient Temperature



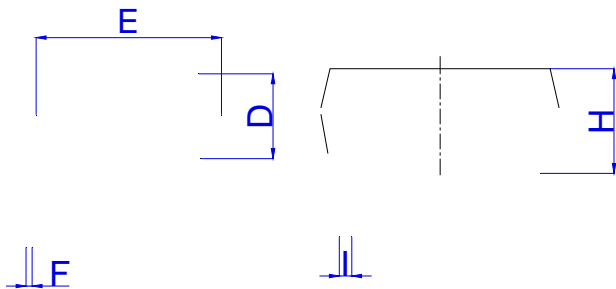
TEST CIRCUITS

Fig.15: Test Circuit for TPHL and TPLH



Package Dimension (Unit: mm)

Standard DIP Type:



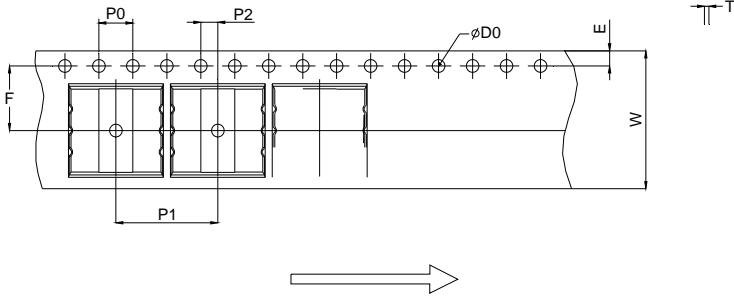
Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	6.20		6.60	0.244		0.260
B	9.40		9.80	0.370		0.386
C	7.15		8.95	0.281		0.352
D	3.20		3.60	0.126		0.142
E	7.32		7.92	0.288		0.312
F	0.15		0.35	0.006		0.014
G	0.90		1.50	0.035		0.059
H	3.90		4.50	0.154		0.177
I	0.40		0.60	0.016		0.024
J						

RECOMMENDED SOLDER MASK (Dimensions in mm unless otherwise stated)



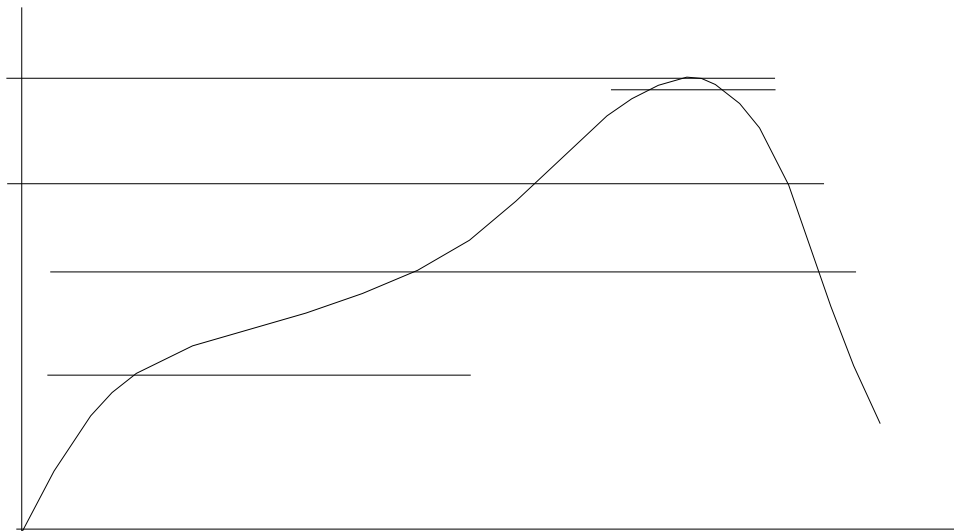
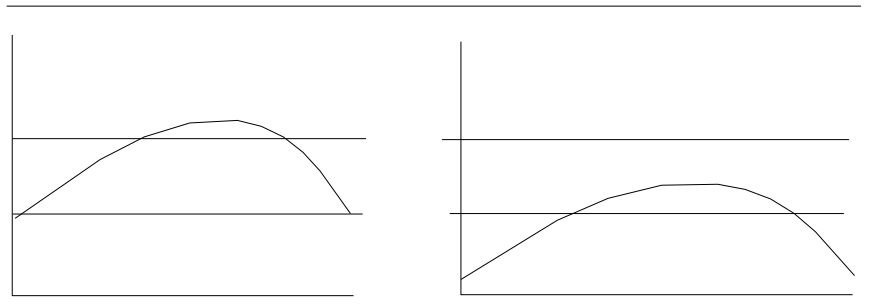
CARRIER TAPE SPECIFICATIONS (Dimensions in mm unless otherwise stated)

Option S/L



Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
D0		1.50	1.60		0.059	0.063
P0	3.90	4.00	4.10	0.154	0.157	0.161
P1	11.90	12.00	12.10	0.469	0.472	0.476
P2	1.90	2.00	2.10	0.075	0.079	0.083
E	1.65	1.75	1.85	0.065	0.069	0.073
F	7.40	7.50	7.60	0.291	0.295	0.299
T	0.35	0.40	0.45	0.014	0.016	0.018
W	15.90	16.00	16.20	0.626	0.630	0.638

REFLOW INFORMATION



JOCHA14B

Note:

1. Reflow soldering is recommended at the temperatures and times shown, no more than three times.
2. Avoid direct contact between the epoxy body and any tools or surfaces exceeding its maximum storage temperature.
3. Application of pressure on the epoxy body is prohibited at elevated temperatures. In specific scenarios, any applied force must not exceed 2.5N.
4. Ensure the component has cooled to ambient temperature before proceeding with any subsequent manufacturing steps.
5. The component has a shelf life of one year when stored under

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